					Con	trol No	A00-119-001	
Me	essrs.			Control No. : A0Q-119-001 Date: 2014/9/1				
				TDK-EPC Corporation Piezo & Protection Devices B.Grp				
		i E B G		Responsible Person of OA: Mr. Etsuo Takah				
Application For Process Chan			nge	Responsible Person of Technology: Mr. Kimio S				
We apply for Process change as follows. Please give us your directions using a "RESPONSEE" sheet shown below.								
Title			Change of the location of plating process					
Customer's part No. Pl		Please refer to the attached	Please refer to the attached file No.1.		TDK part No. P.		ease refer to the attached file No.1.	
	Before Change		After Change		Remarks			
Item of change	Misaki	Chemicals Corporation	TDK Ugo Corporation Iwaki Plant			Regarding 4M, there are no changes occurred to Machine, Material, and Method. There is a change occured to Man out of 4M. Please refer to the attached file No.2. There are no changes occurred to the structure, case size, and electrical specification of the		
Reason for change	TDK will change the location of plating process from Misaki Chemicals Corporation to TDK Ugo Coporation Iwaki Plant due to the integrated manufacture at the TDK Ugo Coporation site. Iwaki Plant has been the production location of inductors, coils, and high frequency wave products. TDK plans to complete all of the production transfer at the end of March, 2015, starting from January 2015. TDK would like to ask and appreciated to confirm below schedule to carry out our plan of technology transfer. Please do not hesitate to contact our sales person with any questions or comments you may have regarding plan of technology transfer. Schedule (Brief Plan) Relocation and lounch: January 2015 ~ Evaluation: Feburary 2015 ~ Start of Mass Productio: March 2015 ~ Start of Delivery: April 2015 ~ *TDK will conduct relocation, launch and evaluation on each facility. TDK plans to start mass production and delivery of the products after passing the evaluation on each facility.							
Scheduled date of Delivery: April. 2015 Prefered date of response: 31.Oct.2014 Attachment: Yes No								
To: TDK-EPC Corporation Piezo & Protection Device B.Grp Response Person in Charge Position of Person in Charge							Charge	
Approval field	<u>Appro</u>	oval for Carry Out:	Yes □ 1	Findings				
		TDK- EPC Co	orporation Pi	eze & Protec	tion Dev	vices B.	.Grp	